

# US Patent & Trademark Office

## Patent Public Search | Text View

United States Patent Application Publication

20250266601

Kind Code

A1

Publication Date

August 21, 2025

Inventor(s)

HATAMIAN; Mehdi et al.

### COMMUNICATION APPARATUS AND METHOD FOR ADAPTIVE COOLING OF ANTENNA ELEMENTS

#### Abstract

A method in a communication apparatus that includes detecting a variation in power consumption in a plurality of antenna elements of an antenna array based on a change in a performance state of the plurality of antenna elements. The includes controlling, based on the detected variation in the power consumption, a plurality of thermoelectric devices of the communication apparatus to substantially equalize a temperature associated with the plurality of antenna elements for a substantial equalization of the performance state of the plurality of antenna elements.

**Inventors:** HATAMIAN; Mehdi (Mission Viejo, CA), KALKUNTE; Venkat (Saratoga, CA)

**Applicant:** PELTBEAM INC. (Sherman Oaks, CA)

**Family ID:** 1000008576733

**Appl. No.:** 19/198197

**Filed:** May 05, 2025

#### Related U.S. Application Data

parent US continuation 18433652 20240206 parent-grant-document US 12021293 child US 18668053

parent US continuation 18363090 20230801 parent-grant-document US 11936093 child US 18433652

parent US continuation 17986043 20221114 parent-grant-document US 11742561 child US 18363090

parent US continuation 17453477 20211103 parent-grant-document US 11527809 child US 17986043

parent US continuation 17321976 20210517 parent-grant-document US 11211682 child US 17453477

parent US division 18668053 20240517 parent-grant-document US 12322854 child US 19198197

## Publication Classification

**Int. Cl.:** H01Q1/02 (20060101); G01J5/12 (20060101); H01Q1/22 (20060101)

**U.S. Cl.:**

**CPC** H01Q1/02 (20130101); H01Q1/2283 (20130101); G01J5/12 (20130101); G01J2005/123 (20130101)

---

## Background/Summary

### CROSS-REFERENCE TO RELATED APPLICATIONS/INCORPORATION BY REFERENCE

[0001] This Patent Application makes reference to, claims priority to, claims the benefit of, and is a Divisional Application of U.S. patent application Ser. No. 18/668,053 filed on May 17, 2024, which is a Continuation Application of U.S. patent Ser. No. 18/433,652 filed on Feb. 6, 2024, which is a Continuation Application of U.S. Pat. No. 11,936,093, granted on Mar. 19, 2024, which is a Continuation Application of U.S. Pat. No. 11,742,561, granted on Aug. 29, 2023, which is a Continuation Application of U.S. Pat. No. 11,527,809, granted on Dec. 13, 2022, which is a Continuation Application of U.S. Pat. No. 11,211,682, granted on Dec. 28, 2021. Each of the above-referenced applications is hereby incorporated herein by reference in its entirety.

### FIELD OF TECHNOLOGY

[0002] Certain embodiments of the disclosure relate to a communication apparatus. More specifically, certain embodiments of the disclosure relate to a communication apparatus and method for adaptive cooling of antenna elements.

### BACKGROUND

[0003] Wireless telecommunication in modern times has witnessed advent of various signal transmission techniques and methods, such as use of beam forming and beam steering techniques, for enhancing capacity of radio channels. In accordance with such techniques, when in operation, an antenna array radiates or receives radio waves in form of beams of radio frequency (RF) signals, which generates significant amount of heat in underlying electronic components. For example, circuits and chips of the antenna array generate significant amount of heat that needs to be removed to keep the circuits and chips at a desired operating temperature range for consistent performance and for avoiding loss of gain due to high temperatures. As electronic components have become faster and more powerful, thermal management in a conventional communication apparatuses and systems, has become a technically challenging issue. For example, for millimeter wave communication capable apparatus, thermal management is a prominent technical challenge for desired performance. Moreover, communication apparatuses, such as a repeater device, a small cell, etc., are mostly deployed outdoors, and thus are subjected to extreme heat, which further aggravates the problem of heating. The conventional approach of using heatsinks and/or fans for cooling such communication systems may result in bulky modules and increase the maintenance cost in the long run, which is not desirable.

[0004] Further limitations and disadvantages of conventional and traditional approaches will become apparent to one of skill in the art, through comparison of such systems with some aspects of the present disclosure as set forth in the remainder of the present application with reference to the drawings.

### BRIEF SUMMARY OF THE DISCLOSURE

[0005] A communication apparatus and method for adaptive cooling of antenna elements, substantially as shown in and/or described in connection with at least one of the figures, as set forth

more completely in the claims.

[0006] These and other advantages, aspects and novel features of the present disclosure, as well as details of an illustrated embodiment thereof, will be more fully understood from the following description and drawings.

---

## Description

### BRIEF DESCRIPTION OF DRAWINGS

[0007] FIG. 1 is a block diagram illustrating various components of an exemplary communication apparatus, in accordance with an exemplary embodiment of the disclosure.

[0008] FIG. 2 is an illustration of an arrangement of a plurality of thermoelectric devices on an antenna array, in accordance with an embodiment of the disclosure.

[0009] FIG. 3 is an illustration of an arrangement of a plurality of thermoelectric devices on an antenna array, in accordance with another embodiment of the disclosure.

[0010] FIGS. 4A, 4B, and 4C collectively, is a flowchart that illustrate a method for adaptive cooling of antenna elements, in accordance with an embodiment of the disclosure.

### DETAILED DESCRIPTION OF THE DISCLOSURE

[0011] Certain embodiments of the disclosure may be found in a communication apparatus and method for adaptive cooling of antenna elements. The communication apparatus and method of the present disclosure not only improves performance of the communication apparatus by maintaining a temperature of the antenna arrays in the communication apparatus in a specified temperature range but also optimizes power consumption by providing a capability of adaptive cooling of antenna elements. The solution provided in the present disclosure reduces the overall maintenance cost of the communication apparatus and provides an intelligent and practical cooling mechanism to ensure operational reliability of the communication apparatus for consistent high-performance communication. In the following description, reference is made to the accompanying drawings, which form a part hereof, and in which is shown, by way of illustration, various embodiments of the present disclosure.

[0012] FIG. 1 is a block diagram illustrating various components of an exemplary communication apparatus, in accordance with an exemplary embodiment of the disclosure. With reference to FIG. 1, there is shown a block diagram 100 of a communication apparatus 102. The communication apparatus 102 may include a control section 104 and a front-end radio frequency (RF) section 106. The control section 104 may include a processor 108 and a memory 110. The control section 104 may be communicatively coupled to the front-end RF section 106. The front-end RF section 106 may include front-end RF circuitry 112, a plurality of antenna arrays, such as a first antenna array 114 and a second antenna array 116, and a plurality of thermoelectric devices, such as a first plurality of thermoelectric devices 118 and a second plurality of thermoelectric devices 120. The first antenna array 114 may include a first plurality of antenna elements 122 and the second antenna array 116 may include a second plurality of antenna elements 124.

[0013] The communication apparatus 102 includes suitable logic, circuitry, and interfaces that may be configured to communicate with one or more network nodes, such as one or more base stations and another repeater devices and user equipment (UEs). In accordance with an embodiment, the communication apparatus 102 may support multiple and a wide range of frequency spectrum, for example, 2G, 3G, 4G, 5G, and 6G (including out-of-band frequencies). The communication apparatus 102 is one of an XG-enabled repeater device, an XG-enabled small cell, or an XG-enabled customer premise equipment (CPE), where the term “XG” refers to 5G or 6G. Other examples of the communication apparatus 102 may include, but is not limited to, a 5G wireless access point, an evolved-universal terrestrial radio access-new radio (NR) dual connectivity (EN-DC) device, a Multiple-input and multiple-output (MIMO)-capable repeater device, or a

combination thereof.

[0014] The processor **108** may be communicatively coupled to the first antenna array **114** and the first plurality of thermoelectric devices **118**. Similarly, the processor **108** may also be communicatively coupled to the second antenna array **116** and the second plurality of thermoelectric devices **120**. The processor **108** may be configured to execute various operations of the communication apparatus **102**. The processor **108** may be configured to control various components of the front-end RF section **106**. The communication apparatus **102** may be a programmable device, where the processor **108** may execute instructions stored in the memory **110**. Example of the implementation of the processor **108** may include, but are not limited to an embedded processor, a microcontroller, a specialized digital signal processor (DSP), a Reduced Instruction Set Computing (RISC) processor, an Application-Specific Integrated Circuit (ASIC) processor, a Complex Instruction Set Computing (CISC) processor, and/or other processors, or state machines.

[0015] The memory **110** may be configured store values, such as determined operational states of the first plurality of antenna elements and the second plurality of antenna elements of the first antenna array and the second antenna array, respectively. Examples of the implementation of the memory **110** may include, but not limited to, a random access memory (RAM), a dynamic random access memory (DRAM), a static random access memory (SRAM), a processor cache, a thyristor random access memory (T-RAM), a zero-capacitor random access memory (Z-RAM), a read only memory (ROM), a hard disk drive (HDD), a secure digital (SD) card, a flash drive, cache memory, and/or other non-volatile memory. It is to be understood by a person having ordinary skill in the art that the control section **104** may further include one or more other components, such as an analog to digital converter (ADC), a digital to analog (DAC) converter, a cellular modem, and the like, known in the art, which are omitted for brevity.

[0016] The front-end RF circuitry **112** includes receiver circuitry and transmitter circuitry. The receiver circuitry is coupled to the one or more receiving antenna arrays, such as one of the first antenna array **114** or the second antenna array **116** or may be a part of the receiver chain. The transmitter circuitry may be coupled to the one or more transmitting antenna arrays, such as the first antenna array **114** or the second antenna array **116** in an implementation. The front-end RF circuitry **112** supports millimeter wave (mmWave) communication as well communication at a sub 6 gigahertz (GHz) frequency.

[0017] Each of the first antenna array **114** and the second antenna array **116** may be one of an XG phased-array antenna panel, an XG-enabled antenna chipset, an XG-enabled patch antenna array, or an XG-enabled servo-driven antenna array, where the “XG” refers to 5G or 6G. The first antenna array **114** has a first side that represents an RF circuitry and chip side and a second side that represents a radiating side of the first plurality of antenna elements **122**. Similarly, the second antenna array **116** has a first side that represents a RF circuitry and chip side and a second side that represents a radiating side of the second plurality of antenna elements **124**.

[0018] The first plurality of thermoelectric devices **118** are arranged on the first plurality of antenna elements **122** of the first antenna array **114** such that each thermoelectric device covers a different subset of antenna elements of the first plurality of antenna elements **122**. Similarly, the second plurality of thermoelectric devices **120** are arranged on the second plurality of antenna elements **124** of the second antenna array **116** such that each thermoelectric device covers a different subset of antenna elements of the second plurality of antenna elements **124**. Each of the thermoelectric devices, such as the first plurality of thermoelectric devices **118** and the second plurality of thermoelectric devices **120**, has a cooling side and a heat dissipation side, and two connection leads. The cooling side each of the first plurality of thermoelectric devices **118** is arranged on the first side (i.e., chip side) of the first antenna array **114**. Similarly, the cooling side each of the second plurality of thermoelectric devices **120** is arranged on the first side (i.e., chip side) of the second antenna array **116**. In an implementation, each of the first plurality of thermoelectric devices

**118** and the second plurality of thermoelectric devices **120** may be a Peltier device. Each of the first plurality of thermoelectric devices **118** and the second plurality of thermoelectric devices **120** do not have any moving parts and circulating liquid, which further contributes to reducing the maintenance cost of the communication apparatus **102**. Such thermoelectric devices manifest a very long life, invulnerability to leaks, and are scalable, lightweight, small in size and even flexible in shape. It is to be understood by one of ordinary skill in the art that other thermoelectric semiconductor devices or thermoelectric coolers may be used without limiting the scope of the disclosure.

[0019] In operation, the processor **108** may be configured to determine an operational state of the first plurality of antenna elements **122**. The operational state indicates a power state or a performance state of the first plurality of antenna elements **122**. The processor **108** may be communicatively coupled to the front-end RF section **106** and may detect the power state or the performance state of the first plurality of antenna elements **122** from the front-end RF circuitry **112**.

[0020] In an implementation, when in operation, the processor **108** may be configured to partition the first plurality of antenna elements **122** into a plurality of subsets of antenna elements (i.e., a plurality of spatially separated antenna sub-arrays). The partition may be done dynamically and may be a logical partition. In one example, the first antenna array **114** may comprise 256 antenna elements and has 16 rows and 16 columns. Thus, each of the plurality of subsets of antenna elements may comprise 64 elements each. The first antenna array **114** may be configured to generate one or more beams of RF signals using the partitions. In another example, the first antenna array **114** includes a plurality of chips arranged to form the first plurality of antenna elements **122** (e.g., one or more subsets of four Tx/Rx chips and one mixer chip, where each Tx/Rx chip may include X-number of antenna elements). In such a case, each of the one or more subsets of four Tx/Rx chips and one mixer chip may correspond to one subset of the plurality of subsets of antenna elements. Moreover, the first plurality of thermoelectric devices **118** are arranged on the first plurality of antenna elements **122** of the first antenna array **114** such that each thermoelectric device covers a different subset of antenna elements of the first plurality of antenna elements **122**. In one example, one thermoelectric device of the first plurality of thermoelectric devices **118** may cover four Tx/Rx chips and a mixer chip. In another example, one thermoelectric device of the first plurality of thermoelectric devices **118** may cover one chip individually. In yet another example, the distribution of the first plurality of thermoelectric devices **118** on the first plurality of antenna elements **122** may be based on an identification of one or more radiation surplus regions and radiation deficient regions in an antenna array. For example, in case of receiver antenna array, the central portion of the first antenna array **114** may be a radiation surplus region and other peripheral areas of the first antenna array **114** may be radiation deficient regions. Thus, in such cases, one or more thermoelectric devices may be arranged on the radiation surplus region, whereas either none or a comparatively less number of thermoelectric devices may be arranged on the radiation deficient regions.

[0021] In accordance with an embodiment, the distribution of the first plurality of thermoelectric devices **118** on the first plurality of antenna elements **122** may be based on a type of antenna array and its deployment preferences. For example, if the first antenna array **114** is to be used as a service side antenna array that faces a plurality of UEs, the number of first plurality of thermoelectric devices **118** used may be higher as compared to a case where the first antenna array **114** is a source side antenna array that faces one or more base stations. This is because if it is known that a location of communication apparatus **102** where it is to be deployed is fixed with respect to the base station, then it can be derived that there will be less changes in beamforming between the communication apparatus **102** and the one or more base stations resulting in less power consumption and heat generation, and in turn low cooling requirements on the source side antenna array. However, if the communication apparatus **102** is a repeater device installed on a moving object, such as a vehicle, then in such a case, the source side antenna array that faces one or more base stations may require

continuous changes in beamforming patterns, resulting in heat generation by the underlying electronic components (e.g., circuitry and chips) of the first antenna array **114**. Thus, in such cases, the number of first plurality of thermoelectric devices **118** on the first antenna array **114** designated as the source side antenna array may be higher and distribution may be dense based on expected exposure of the first plurality of antenna elements **122** to beams of RF signals of the first antenna array **114**. On the contrary, the first antenna array **114** when arranged to face an interior of the vehicle, then either none or a comparatively less number of thermoelectric devices may be used to save power.

[0022] The processor **108** may be further configured to control each of the first plurality of thermoelectric devices **118** based on the determined operational state of the first plurality of antenna elements **122** such that an adaptive cooling is applied on different subsets of antenna elements of the first plurality of antenna elements **122** to maintain a temperature of the first plurality of antenna elements **122** in a specified temperature range. Not all the first plurality of antenna elements **122** may be operational at a given point in time, or more heating may be generated at some subsets of antenna elements as compared to other subsets of the first plurality of antenna elements **122**. Thus, the information of the operational state of each of plurality of subsets of antenna elements may be leveraged to control, for example, activate corresponding thermoelectric devices of only such subsets of antenna elements that require comparatively more cooling. This results in an overall adaptive cooling system with an on-demand performance. When the chips and circuitry associated with such subsets of antenna elements that require comparatively more cooling, are subjected to cooling by use of corresponding thermoelectric devices arranged on such subsets of antenna elements, a desired operating temperature range is maintained, which results in improved (i.e., optimum) performance and avoids any potential loss of gain due to high temperatures.

[0023] In accordance with an embodiment, the determination of the operational state of the first plurality of antenna elements **122** may comprise determining which antenna elements of the first plurality of antenna elements **122** are in an activated state and which are in a deactivated state. In such a case, the control of each of the first plurality of thermoelectric devices **118** may comprise executing an activation or a deactivation of each of first plurality of thermoelectric devices **118** in synchronization with the activated state or deactivated state of the different subsets of antenna elements of the first plurality of antenna elements **122**. In an example, a first thermoelectric device may cover a first subset of antenna elements, a second thermoelectric device may cover a second subset of antenna elements, a third thermoelectric device may cover a third subset of antenna elements, and a fourth thermoelectric device may cover a fourth subset of antenna elements of the first plurality of antenna elements **122**. The coverage of the different subsets of antenna elements implies an arrangement where the cooling side of each thermoelectric device is placed on the corresponding subset of antenna elements such that when input voltage is supplied to a given thermoelectric device, a temperature difference is generated across the two sides of the given thermoelectric device. The cooling side of the given thermoelectric device passes the cooling to the circuitry and chips associated with the corresponding subset of antenna elements to maintain the temperature of the corresponding subset of antenna elements in the specified temperature range. The heat dissipation side of the given thermoelectric device dissipates the heat outside the communication apparatus. In some embodiments, for the heat dissipation, a modular heat sink may be employed, which may have a size that is less than a defined threshold size. In this case, for instance, the first subset of antenna elements and the second subset of antenna elements may be determined to be in the activated state, whereas the third and fourth subset of antenna elements may be determined to be in the deactivated state. In such a case, the processor **108** may be configured to activate the first thermoelectric device and the second thermoelectric device and voltage may be supplied to provide cooling to the first subset of antenna elements and the second subset of antenna elements, respectively. However, the third thermoelectric device and the fourth thermoelectric

device may not be activated. In an implementation, the activation of the first thermoelectric device and the second thermoelectric device may be in a real-time or near real-time as soon as the first subset of antenna elements and the second subset of antenna elements starts its operation. In another implementation, the activation of the first thermoelectric device and the second thermoelectric device may be executed in a defined delayed time, for example, after a certain time has elapsed from the start of operation of the first subset of antenna elements and the second subset of antenna elements. The defined delayed time may be pre-set at the communication apparatus **102** or may be calculated dynamically.

[0024] In accordance with an embodiment, the communication apparatus **102** may comprise an array of temperature sensors to measure temperature of each chip (i.e. each antenna chip) of the plurality of chips of an antenna array, such as the first antenna array **114**. Accordingly, the control of each of the first plurality of thermoelectric devices **118** may comprise changing a voltage input to cause a corresponding change in a temperature of the first plurality of thermoelectric devices **118** such that the adaptive cooling is applied on different subsets of antenna elements of the first plurality of antenna elements **122** based on the measured temperature from the array of temperature sensors.

[0025] In accordance with another embodiment, the array of temperature sensors may not be used, and the determination of the operational state of the first plurality of antenna elements **122** may comprise determining a performance state of the first plurality of antenna elements **122** of the first antenna array **114**. In such a case, the control of each of the first plurality of thermoelectric devices **118** may comprise changing a voltage input to cause a corresponding change in a temperature of the first plurality of thermoelectric devices **118** such that the adaptive cooling is applied on different subsets of antenna elements of the first plurality of antenna elements **122**. Based on experimentation, it is observed that when the temperature changes (e.g. high heat generated), the output power of an antenna, such as the first antenna array **114** also changes, and the overall performance of wireless communication by such antenna, such as the first antenna array **114**, is affected. Thus, the performance state of the communication apparatus **102** based on communication by the first antenna array **114** may be detected. In other words, a performance drop, such as a gain drop, a connectivity drop, a voice drop, a power output drop, or any sudden drops in performance may be attributed to the high heat generated. Such performance state may be used as a feedback to change the voltage input to one or more thermoelectric devices of the first plurality of thermoelectric devices **118** to cause desired cooling from the one or more thermoelectric devices to reduce fluctuation of temperature changes and maintain the temperature of the chips and circuitry associated with the first plurality of antenna elements **122** within the desired temperature range in order to optimize performance and prevent any potential loss of gain and other performance drops due to high temperatures.

[0026] In another implementation, the control of each of the first plurality of thermoelectric devices **118** may comprise substantially equalizing temperature associated with the first plurality of antenna elements **122** such that the performance state of the first plurality of antenna elements **122** of the first antenna array **114** is substantially equalized. There may be variation in power consumption of chips in the first antenna array **114**, and as result there may be a difference in heat generation from the different chips. The processor **108** may be further configured to detect such variations based on a change in the performance state of such chips as compared to other chips of the first antenna array **114**. By substantially equalizing the temperature associated with the first plurality of antenna elements **122**, the performance of the first plurality of antenna elements **122** is substantially equalized. If the equalization is maintained within a range of about 0-10 percent difference, it can be considered as substantially equalizing as it does not generate any noticeable effect on performance. For example, by substantially equalizing the temperature associated with the first plurality of antenna elements **122**, an equalization of gain across different regions of the first antenna array **114** may be achieved.

[0027] In an implementation, the first antenna array **114** may be a receiver antenna array, and thus by substantially equalizing the temperature associated with the first plurality of antenna elements **122**, a distribution of gain may be further equalized across the first plurality of antenna elements **122** to achieve optimal power output from the received beam of input RF signals at different scan angles for the first antenna array **114**. Moreover, by substantially equalizing the temperature associated with the first plurality of antenna elements **122**, a desired transmit/receive power may be consistently maintained.

[0028] In accordance with an embodiment, the processor **108** may be further configured to obtain traffic information of a geographical area surrounding a deployed location of the communication apparatus **102**. In such a case, the control of each of the first plurality of thermoelectric devices **118** further comprises increasing or decreasing cooling from each of the first plurality of thermoelectric devices **118** based on the obtained traffic information that indicates a number of user equipment (UEs) to be served in the geographical area. As the number of UEs to be serviced increases, the power consumption also increases at the first antenna array **114** to keep the first antenna array **114** functional to generate one or more beams. Thus, more voltage input may be supplied to some thermoelectric devices to provide more cooling to some chips covering corresponding subsets of antenna elements, where more cooling is required as per demand in such situations. The use of the traffic information as a parameter to decide the amount of cooling needed in advance prevents any unwanted deterioration of performance of the first antenna array **114**.

[0029] In accordance with an embodiment, the processor **108** may be further configured to obtain in a real time or a near real time one or more of: a weather condition, a position information of one or more UEs to be served by the first antenna array **114**, a two-dimensional (2D) or three-dimensional (3D) position information of the communication apparatus **102**. In such a case, the control of each of the first plurality of thermoelectric devices **118** may further comprise increasing or decreasing cooling from each of the first plurality of thermoelectric devices **118** based on one or more of the obtained weather condition, the position information of one or more UEs to be served by the first antenna array **114**, and the 2D or 3D position information of the communication apparatus **102**. The communication apparatus **102** may be deployed outdoors, and thus may be subjected to extreme heat due to exposure to sunlight on a given day, which further increases the problem of heating during operation. Thus, in some implementations, the parameter of weather condition is also employed to decide how much cooling is needed to maintain a temperature of the first plurality of antenna elements **122** in the specified temperature range, for example, 20-30 degree Celsius. Moreover, the position of each of one or more UEs to be served by the first antenna array **114** with respect to the position of the communication apparatus **102** indicates a corresponding distance of the one or more UEs from the communication apparatus **102**. Thus, a beam shape (i.e., a radiation pattern) used to serve a UE may have a specific need of power consumption and heating of certain antenna elements based on a direction of the beam to be transmitted to service the UE. Thus, circuitry and chips connected with such antenna elements may need more cooling, and thus more input voltage may be supplied to those thermoelectric devices that covers such antenna elements to generate more cooling as compared to other thermoelectric devices of the first plurality of thermoelectric devices **118**.

[0030] In accordance with an embodiment, like the first antenna array **114**, the processor **108** may be further configured to determine an operational state of the second plurality of antenna elements **124**, and control each of the second plurality of thermoelectric devices **120** based on the determined operational state of the first plurality of antenna elements **122** as well as the second plurality of antenna elements **124**.

[0031] In accordance with an embodiment, the first antenna array **114** may be a service side antenna array that faces a plurality of UEs and the second antenna array **116** may be a source side antenna array that faces one or more base stations. In such a case, the second plurality of thermoelectric devices **120** may be less than the first plurality of thermoelectric devices **118**. In a



case where the position of communication apparatus **102** with respect to the base station do not change, it can be derived that there will be comparatively less changes in beamforming resulting in less power consumption and heat generation at the source side antenna array as compared to the service side antenna array. This results in lower cooling needs at the source side antenna array as compared to the service side antenna array. Thus, in such cases, the second plurality of thermoelectric devices **120** may be less than the first plurality of thermoelectric devices **118**. In accordance with another embodiment, both the first antenna array **114** and the second antenna array **116** may be service side antenna arrays that faces a plurality of UEs or another communication apparatus **102**. In such a case, the second plurality of thermoelectric devices **120** may be equal to the first plurality of thermoelectric devices **118**.

[0032] In an exemplary implementation, the communication apparatus **102** may be installed in a vehicle as a repeater device. The first antenna array **114** and the second antenna array **116** may be mounted at different locations of the vehicle. In such a case, one of the first antenna array **114** and the second antenna array **116** may be configured to be activated or deactivated based on a visibility status to a network node, such as a base station or a roadside unit, when the vehicle is in motion. In such a case, the processor **108** may be further configured to control activation or a deactivation of each of the first plurality of thermoelectric devices **118** and the second plurality of thermoelectric devices **120** in accordance with the activation or deactivation of the first antenna array **114** or the second antenna array **116** based on the visibility status.

[0033] For the sake of brevity, the aforementioned implementations (and embodiments) are described with two antenna arrays in the communication apparatus **102**. However, it is to be understood by a person of ordinary skill in the art that such implementations and embodiments can be extended to cover cases of N antenna arrays and M thermoelectric devices, without limiting the scope of the disclosure.

[0034] FIG. 2 is an illustration of an arrangement of a plurality of thermoelectric devices on an antenna array, in accordance with an embodiment of the disclosure. FIG. 2 is explained in conjunction with elements from FIG. 1. With reference to FIG. 2, there is shown an antenna array **202** and a plurality of thermoelectric devices, such as a first thermoelectric device **204A**, a second thermoelectric device **204B**, a third thermoelectric device **204C**, and a fourth thermoelectric device **204D**.

[0035] In this embodiment, the antenna array **202** corresponds to the first antenna array **114** and the second antenna array **116**. Similarly, the plurality of thermoelectric devices **204** corresponds to the first plurality of thermoelectric devices **118** and the second plurality of thermoelectric devices **120**. In FIG. 2, each of the plurality of thermoelectric devices has a cooling side **206A** and a heat dissipation side **206B**, as shown. The antenna array **202** has a first side **208A** that represents a radio frequency (RF) circuitry and chip side and a second side **208B** that represents a radiating side of a plurality of antenna elements of the antenna array **202**. The cooling side **206A** of each of the plurality of thermoelectric devices is arranged on the first side **208A** of the antenna array. The plurality of thermoelectric devices **204** may be arranged on the plurality of antenna elements of the antenna array **202** such that each thermoelectric device covers a different subset of antenna elements of the plurality of antenna elements of the antenna array **202**.

[0036] FIG. 3 is an illustration of an arrangement of a plurality of thermoelectric devices on an antenna array, in accordance with another embodiment of the disclosure. FIG. 3 is explained in conjunction with elements from FIGS. 1 and 2. With reference to FIG. 3, there is shown an antenna array **302** and a plurality of thermoelectric devices **304A**, **304B**, **304C**, **304D**, **304E**, and **304F**. There is further shown a motherboard **306** that supports a plurality of chips arranged on the first side **302A** of the antenna array **302** and connected with different antenna elements of a plurality of antenna elements of the antenna array **302** that radiates from a second side that is opposite to the first side **302A**.

[0037] In accordance with an embodiment, the cooling side of the plurality of thermoelectric

devices **304A**, **304B**, **304C**, **304D**, **304E**, and **304F** may be arranged on the antenna array **302** such that each thermoelectric device covers a different subset of antenna elements (i.e., covers one or more chips associated with each subset of antenna elements) of the antenna array **302** from the first side **302A** (i.e. the chips and circuitry side). It is to be understood by one of ordinary skill in the art that selection of number and size of the thermoelectric device may depend on its application or requirement, without limiting the scope of the disclosure. For example, in an exemplary implementation, one thermoelectric device may cover four chips. In another implementation, one thermoelectric device may cover 8-10 Tx/Rx chips including mixer chips. In yet another implementation, only two or four thermoelectric devices may be used to cover one antenna array. [0038] FIGS. **4A**, **4B**, and **4C** collectively is a flowchart that illustrates a method for adaptive cooling of antenna elements, in accordance with an embodiment of the disclosure. FIGS. **4A**, **4B**, and **4C** are explained in conjunction with elements from FIGS. **1** to **3**. With reference to FIGS. **4A** to **4C**, there is shown a flowchart **400** comprising exemplary operations **402** through **408**. The operations of the method depicted in the flowchart **400** may be implemented in the communication apparatus **102** (FIG. **1**).

[0039] At **402**, an operational state of the first plurality of antenna elements **122** may be determined. The determination of the operational state of the first plurality of antenna elements **122** devices may further comprise one or more sub-operations corresponding to operations **402A** and **402F**.

[0040] At **402A**, it may be determined which antenna elements of the first plurality of antenna elements **122** are in an activated state and which are in a deactivated state. At **402B**, a performance state of the first plurality of antenna elements **122** of the first antenna array **114**, may be determined. At **402C**, traffic information may be obtained of a geographical area surrounding a deployed location of the communication apparatus. At **402D**, an operational state of the first plurality of antenna elements **122** may be proactively predicted based on the obtained traffic information. At **402E**, it may be obtained in a real time or a near real time one or more of: a weather condition, a position information of one or more UEs to be served by the first antenna array **114**, a two-dimensional (2D) or three-dimensional (3D) position information of the communication apparatus **102**. At **402F**, an operational state of the first plurality of antenna elements **122** may be proactively predicted based on the obtained weather condition, the position information of one or more UEs to be served by the first antenna array **114**, and the 2D or 3D position information of the communication apparatus **102**.

[0041] At **404**, each of the first plurality of thermoelectric devices **118** may be controlled based on the determined operational state of the first plurality of antenna elements **122** such that an adaptive cooling is applied on different subsets of antenna elements of the first plurality of antenna elements **122** to maintain a temperature of the first plurality of antenna elements **122** in a specified temperature range. The control of each of the first plurality of thermoelectric devices **118** further comprises one or more sub-operations corresponding to operations **404A** to **404E**.

[0042] At **404A**, an activation or a deactivation of each of first plurality of thermoelectric devices may be executed in synchronization with the activated state or deactivated state of the different subsets of antenna elements of the first plurality of antenna elements **122**. At **404B**, a voltage input may be changed to cause a corresponding change in a temperature of the first plurality of thermoelectric devices **118** such that the adaptive cooling is applied on different subsets of antenna elements of the first plurality of antenna elements **122**. At **404C**, temperature associated with the first plurality of antenna elements **122** may be substantially equalized such that the performance state of the first plurality of antenna elements **122** of the first antenna array **114** is also substantially equalized. At **404D**, cooling from each of the first plurality of thermoelectric devices **118** may be increased or decreased based on the obtained traffic information that indicates a number of user equipment (UEs) to be served in the geographical area. At **404E**, cooling from each of the first plurality of thermoelectric devices **118** may be increased or decreased based on one or more of: the

obtained weather condition, the position information of one or more UEs to be served by the first antenna array **114**, and the 2D or 3D position information of the communication apparatus **102**. [0043] At **406**, an operational state of the second plurality of antenna elements **124** may be determined. At **408**, each of the second plurality of thermoelectric devices **120** may be controlled based on the determined operational state of the first plurality of antenna elements **122** as well as the second plurality of antenna elements **124**.

[0044] It is known that conventional approach of using heatsinks and/or fans for cooling existing communication apparatus, such as a repeater device, may result in bulky modules which make it impractical to use servo-driven antenna arrays for optimum performance. To alleviate the problem, the intelligent use of the thermoelectric devices for adaptive cooling based on operational state of antenna elements of a given antenna array improves the reliability of communication, such as mmWave communication, to meet data communication in multi-gigabit data rate, by significantly reducing performance breakdowns due to heating of chips and driver circuits associated with such antenna elements. The use of the thermoelectric devices for adaptive cooling based on operational state of antenna elements results in a temperature difference of up to, for example, 25 degree Celsius approximately.

[0045] Various embodiments of the disclosure may provide a non-transitory computer-readable medium having stored thereon, computer implemented instructions that when executed by a computer causes a communication apparatus **102** to execute operations, the operations comprising determining an operational state of the first plurality of antenna elements **122** of the first antenna array **114**; and controlling each of the first plurality of thermoelectric devices **118** based on the determined operational state of the first plurality of antenna elements **122** such that an adaptive cooling is applied on different subsets of antenna elements of the first plurality of antenna elements **122** to maintain a temperature of the first plurality of antenna elements **122** in a specified temperature range.

[0046] Various embodiments of the disclosure may include a communication apparatus **102**, for example, a repeater device, a small cell, or an edge repeater device. The communication apparatus **102** comprises the first antenna array **114** that comprises a first plurality of antenna elements **122**. The communication apparatus **102** further comprises the first plurality of thermoelectric devices **118** that may be arranged on the first plurality of antenna elements **122** of the first antenna array **114** such that each thermoelectric device covers a different subset of antenna elements of the first plurality of antenna elements **122**. The communication apparatus **102** further comprises a processor **108** communicatively coupled to the first antenna array **114** and the first plurality of thermoelectric devices **118**, wherein the processor **108** may be configured to: determine an operational state of the first plurality of antenna elements **122**; and control each of the first plurality of thermoelectric devices **118** based on the determined operational state of the first plurality of antenna elements **122** such that an adaptive cooling may be applied on different subsets of antenna elements of the first plurality of antenna elements **122** to maintain a temperature of the first plurality of antenna elements **122** in a specified temperature range.

[0047] In accordance with an embodiment, each of the thermoelectric devices has the cooling side **206A** and the heat dissipation side **206B**, and wherein the first antenna array **114** has the first side **208A** that represents a radio frequency (RF) circuitry and chip side and the second side **208B** that represents a radiating side of the first plurality of antenna elements **122**, and wherein the cooling side **206A** each of the thermoelectric device may be arranged on the first side **208A** of the first antenna array **114**.

[0048] In accordance with an embodiment, the determination of the operational state of the first plurality of antenna elements **122** comprises determining which antenna elements of the first plurality of antenna elements **122** may be in an activated state and which may be in a deactivated state. The control of each of the first plurality of thermoelectric devices **118** comprises executing an activation or a deactivation of each of first plurality of thermoelectric devices in synchronization

with the activated state or deactivated state of the different subsets of antenna elements of the first plurality of antenna elements **122**.

[0049] In accordance with an embodiment, the determination of the operational state of the first plurality of antenna elements **122** comprises determining a performance state of the first plurality of antenna elements **122** of the first antenna array **114**. The control of each of the first plurality of thermoelectric devices **118** comprises changing a voltage input to cause a corresponding change in a temperature output from each of the first plurality of thermoelectric devices **118** such that the adaptive cooling may be applied on different subsets of antenna elements of the first plurality of antenna elements **122**. In accordance with an embodiment, the control of each of the first plurality of thermoelectric devices **118** comprises substantially equalizing temperature associated with the first plurality of antenna elements **122** such that the performance state of the first plurality of antenna elements **122** of the first antenna array **114** may be substantially equalized.

[0050] In accordance with an embodiment, the processor **108** may be further configured to obtain traffic information of a geographical area surrounding a deployed location of the communication apparatus. The control of each of the first plurality of thermoelectric devices **118** further comprises increasing or decreasing cooling from each of the first plurality of thermoelectric devices **118** based on the obtained traffic information that indicates a number of user equipment (UEs) to be served in the geographical area.

[0051] In accordance with an embodiment, the processor **108** may be further configured to obtain in a real time or a near real time one or more of a weather condition, a position information of one or more UEs to be served by the first antenna array **114**, a two-dimensional (2D) or three-dimensional (3D) position information of the communication apparatus **102**. The control of each of the first plurality of thermoelectric devices **118** further comprises increasing or decreasing cooling from each of the first plurality of thermoelectric devices **118** based on one or more of the obtained weather condition, the position information of one or more UEs to be served by the first antenna array **114**, and the 2D or 3D position information of the communication apparatus **102**.

[0052] In accordance with an embodiment, the communication apparatus **102** further comprises the second antenna array **116** that comprises the second plurality of antenna elements **124**. The communication apparatus **102** further comprises the second plurality of thermoelectric devices **120** that may be arranged on the second plurality of antenna elements **124** of the second antenna array **116** such that each thermoelectric device covers a different subset of antenna elements of the second plurality of antenna elements **124**. The processor **108** maybe communicatively coupled to the second antenna array **116** and the second plurality of thermoelectric devices **120**. The processor **108** may be further configured to determine an operational state of the second plurality of antenna elements **124**, and control each of the second plurality of thermoelectric devices **120** based on the determined operational state of the first plurality of antenna elements **122** as well as the second plurality of antenna elements **124**.

[0053] In accordance with an embodiment, the first antenna array **114** may be a service side antenna array that faces a plurality of UEs and the second antenna array **116** may be a source side antenna array that faces one or more base stations, where the second plurality of thermoelectric devices **120** may be less than the first plurality of thermoelectric devices **118**. In accordance with another embodiment, both the first antenna array **114** and the second antenna array **116** may be service side antenna arrays that faces a plurality of UEs or another communication apparatus, wherein the second plurality of thermoelectric devices **120** may be equal to the first plurality of thermoelectric devices **118**.

[0054] In accordance with an embodiment, the communication apparatus **102** may be one of: an XG-enabled repeater device, an XG-enabled small cell, or an XG-enabled customer premise equipment (CPE), and wherein the first antenna array **114** and the second antenna array **116** may be one of: an XG phased-array antenna panel, an XG-enabled antenna chipset, an XG-enabled patch antenna array, and wherein the XG refers to 5G or 6G.

[0055] While various embodiments described in the present disclosure have been described above, it should be understood that they have been presented by way of example, and not limitation. It is to be understood that various changes in form and detail can be made therein without departing from the scope of the present disclosure. In addition to using hardware (e.g., within or coupled to a central processing unit (“CPU”), microprocessor, micro controller, digital signal processor **108**, processor **108** core, system on chip (“SOC”) or any other device), implementations may also be embodied in software (e.g. computer readable code, program code, and/or instructions disposed in any form, such as source, object or machine language) disposed for example in a non-transitory computer-readable medium configured to store the software. Such software can enable, for example, the function, fabrication, modeling, simulation, description and/or testing of the apparatus and methods described herein. For example, this can be accomplished through the use of general program languages (e.g., C, C++), hardware description languages (HDL) including Verilog HDL, VHDL, and so on, or other available programs. Such software can be disposed in any known non-transitory computer-readable medium, such as semiconductor, magnetic disc, or optical disc (e.g., CD-ROM, DVD-ROM, etc.). The software can also be disposed as computer data embodied in a non-transitory computer-readable transmission medium (e.g., solid state memory any other non-transitory medium including digital, optical, analog-based medium, such as removable storage media). Embodiments of the present disclosure may include methods of providing the apparatus described herein by providing software describing the apparatus and subsequently transmitting the software as a computer data signal over a communication network including the internet and intranets.

[0056] It is to be further understood that the system described herein may be included in a semiconductor intellectual property core, such as a microprocessor **108** core (e.g., embodied in HDL) and transformed to hardware in the production of integrated circuits. Additionally, the system described herein may be embodied as a combination of hardware and software. Thus, the present disclosure should not be limited by any of the above-described exemplary embodiments but should be defined only in accordance with the following claims and their equivalents.

## Claims

1. A method, comprising: in a communication apparatus: detecting a variation in power consumption in a plurality of antenna elements of an antenna array of the communication apparatus based on a change in a performance state of the plurality of antenna elements; and controlling, based on the detected variation in the power consumption, a plurality of thermoelectric devices of the communication apparatus to substantially equalize a temperature associated with the plurality of antenna elements for a substantial equalization of the performance state of the plurality of antenna elements.
2. The method according to claim 1, further comprising: determining the performance state of the plurality of antenna elements of the antenna array; detecting an operational state of each antenna element of the plurality of antenna elements of the antenna array; and executing an activation or a deactivation of each thermoelectric device of the plurality of thermoelectric devices based on the detected operational state and the determined performance state, wherein the execution of the activation or the deactivation is after a specific time has elapsed from a start of operation of the antenna array.
3. The method according to claim 1, further comprising controlling, based on the substantial equalization of the temperature associated with the plurality of antenna elements, equalization of a distribution of gain across the plurality of antenna elements.
4. The method according to claim 1, further comprising: predicting an operational state of each antenna element of the plurality of antenna elements of the antenna array based on position information of at least one user equipment to be served by the antenna array, and position

information of the communication apparatus; and controlling, based on the operational state, the plurality of thermoelectric devices to change cooling from each of the plurality of thermoelectric devices to the plurality of antenna elements.

**5.** The method according to claim 1, wherein each subset of a plurality of subsets of the plurality of antenna elements corresponds to four transmitter-receiver (Tx/Rx) chips and one mixer chip, and each thermoelectric device of the plurality of thermoelectric devices covers the four Tx/Rx chips and the one mixer chip of a respective subset of the plurality of subsets of the plurality of antenna elements.

**6.** The method according to claim 1, wherein each subset of a plurality of subsets of the plurality of antenna elements corresponds to eight to ten transmitter-receiver (Tx/Rx) chips including one or more mixer chips, and each thermoelectric device of the plurality of thermoelectric devices covers the eight to ten transmitter-receiver (Tx/Rx) chips including the one or more mixer chips of a respective subset of the plurality of subsets of the plurality of antenna elements.

**7.** The method according to claim 1, further comprising identifying at least one radiation surplus region and a radiation deficient region in the antenna array, wherein a distribution of the plurality of thermoelectric devices on the plurality of antenna elements is based on the identification of the at least one radiation surplus region and the radiation deficient region in the antenna array.

**8.** The method according to claim 7, wherein a number of thermoelectric devices of the plurality of thermoelectric devices on the at least one radiation surplus region is higher than the radiation deficient region in the antenna array.

**9.** The method according to claim 1, further comprising obtaining traffic information of a geographical area surrounding a location of the communication apparatus.

**10.** The method according to claim 9, further comprising controlling, based on the traffic information of the geographical area, each thermoelectric device of the plurality of thermoelectric devices to apply an adaptive cooling on the plurality of antenna elements.

**11.** The method according to claim 1, further comprising: determining the performance state of the plurality of antenna elements, wherein the determined performance state comprises at least one of: a performance drop, a gain drop, a connectivity drop, a voice drop, a power output drop associated with the antenna array; and executing one of an activation or a deactivation of each thermoelectric device of the plurality of thermoelectric devices in real-time or near real-time based on the determined performance state, wherein the execution of the activation or the deactivation is after a specific time has elapsed from a start of operation of the antenna array.

**12.** The method according to claim 1, further comprising obtaining position information of at least one user equipment to be served by the antenna array.

**13.** The method according to claim 12, further comprising changing cooling from each of the plurality of thermoelectric devices to the plurality of antenna elements based on the obtained position information of the at least one user equipment.

**14.** The method according to claim 12, further comprising increasing or decreasing cooling from each thermoelectric device of the plurality of thermoelectric devices to a plurality of subsets of the plurality of antenna elements based on the obtained position information of the at least one user equipment.

**15.** The method according to claim 1, further comprising determining a state of each subset of a plurality of subsets of the plurality of antenna elements is one of an activated state or a deactivated state.

**16.** The method according to claim 15, further comprising executing synchronization of activation and deactivation of each of the plurality of thermoelectric devices with the activated state or the deactivated state of the plurality of subsets of the plurality of antenna elements of the antenna array.

**17.** The method according to claim 1, wherein the antenna array is a service side antenna array that faces a plurality of user equipment (UEs).

**18.** The method according to claim 1, wherein the communication apparatus is one of: a 5G or 6G-

enabled repeater device, a 5G or 6G-enabled small cell, or a 5G or 6G-enabled customer premise equipment (CPE).

---